

OPENPICS PROJECT

WP4 – review meeting

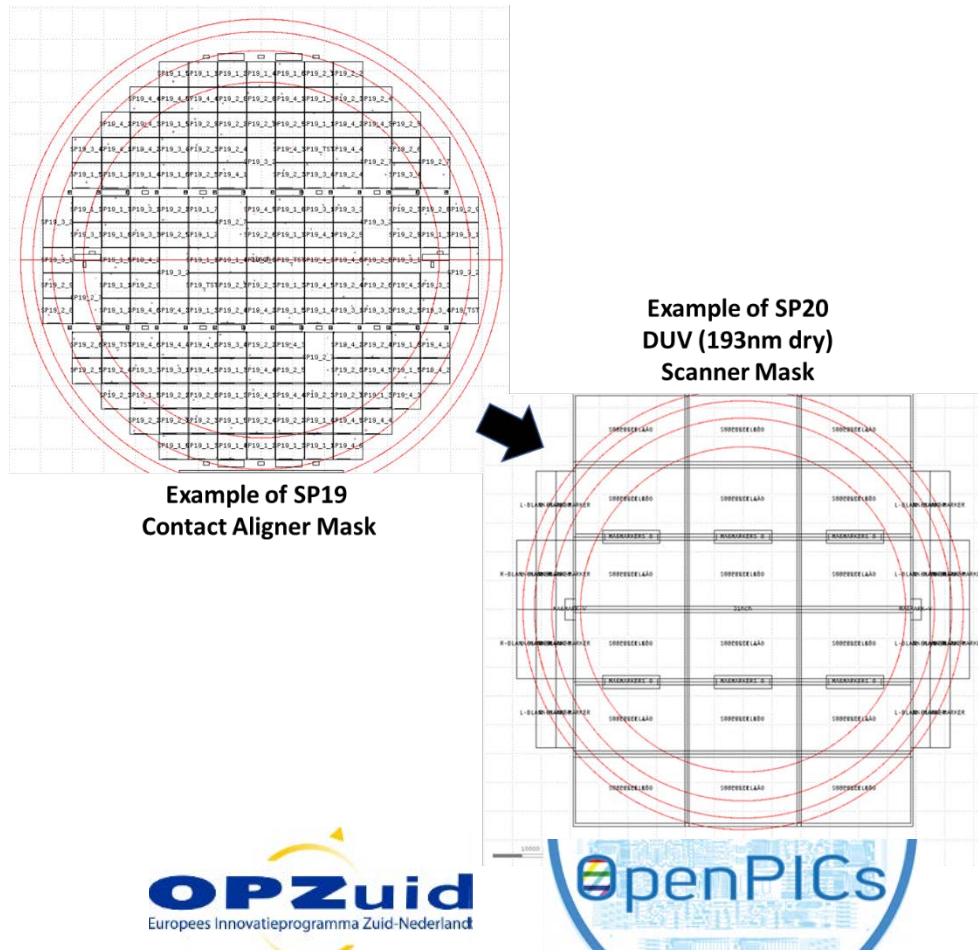
29th August 2017

OUTLINE

- Process development
 - Scanner lithography
 - Etching development
 - Support for Zn diffusion experiments
- Photonic Design Kit (PDK) developments
- Summary

PROCESS DEVELOPMENT

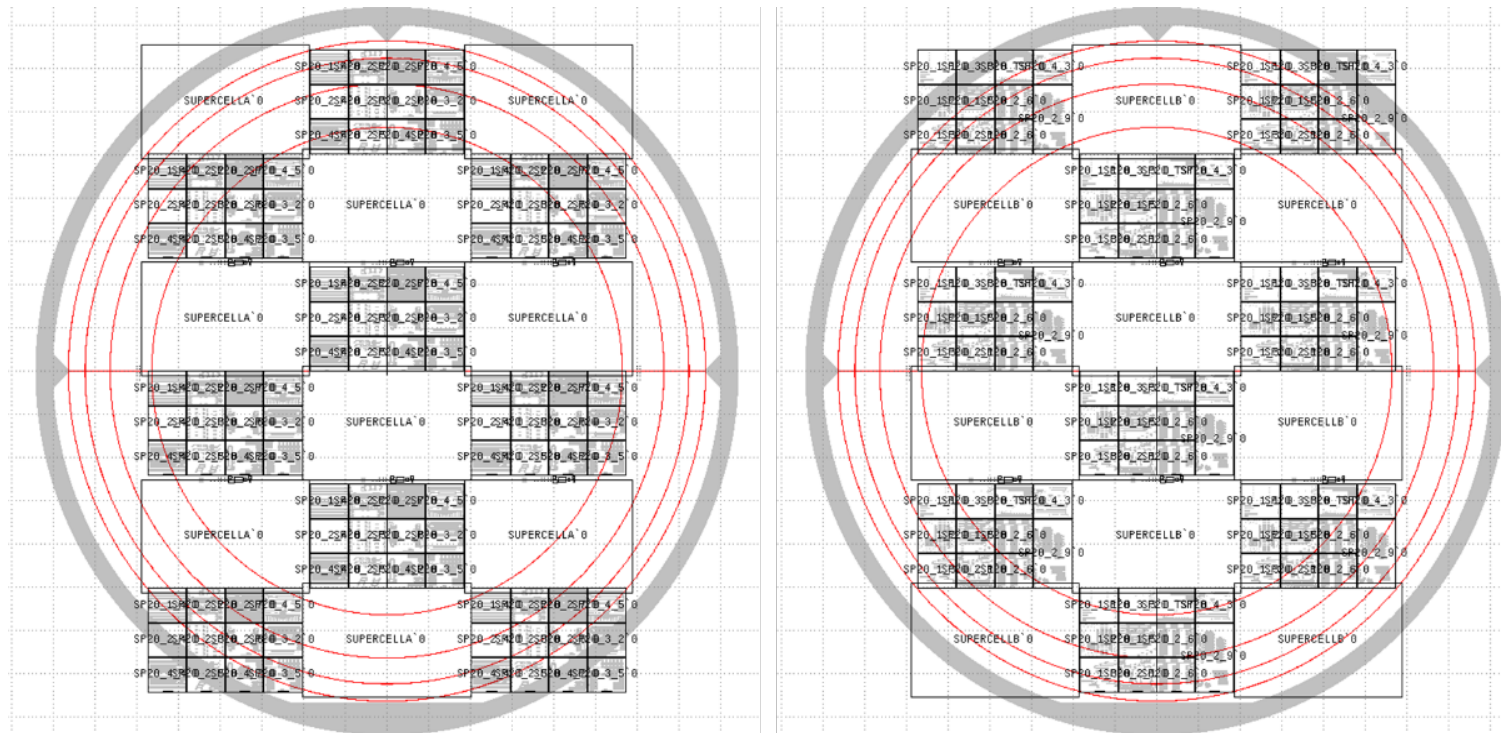
- Scanner Lithography development (reported in WP4-M5.1)



- For the DUV approach so-called super cells have been created, which fit 12 MPW cells of 4x4.6mm. A single supercell can be replicated 18 times on a 3 inch wafer.

PROCESS DEVELOPMENT

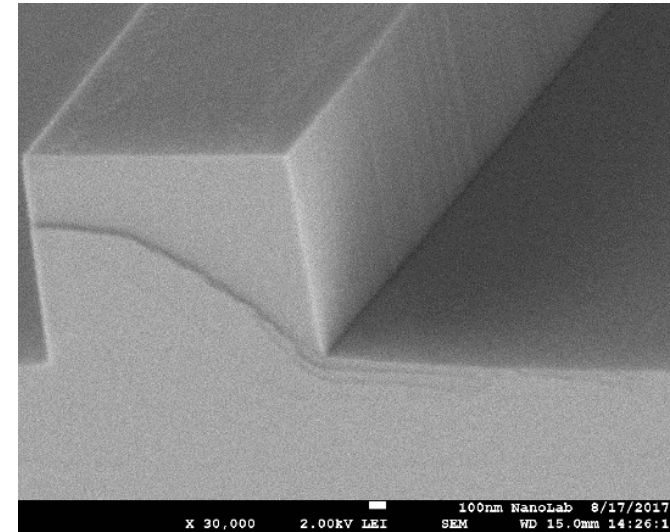
- Actual SP20 implementation



- 2 supercells with 12 dies each, being replicated 9 times

PROCESS DEVELOPMENT

- Etching development
- A new CH₄-H₂ recipe was developed showing:
 - Etchrate: 71.7 nm/min
 - Side wall angle: 0.44°
 - Hard mask erosion: 2.1 nm/min



- Recipe is now at validation stage.

PROCESS DEVELOPMENT

- Support for Zn diffusion experiments
- 4 wafers were grown in our multi-reactor for Zn diffusion experiments

passive

Layer	Material	Doping	d [nm]
III-3	p-InGaAs	$1.5 \cdot 10^{19}$	300
III-2	p-InP	$1.0 \cdot 10^{18}$	1000
III-1	p-InP	low 10^{17}	300
II-2	n-InP	low 10^{16}	200
II-1	n-Q1.25	low 10^{16}	500
I-2	n-InP	low 10^{17}	500
I-1	n-InP	low 10^{18}	500
I-0	n-InP	$1-4 \cdot 10^{18}$	substrate

PDK DEVELOPMENT

- A new Design Manual has been released
 - Update of the performance data of BB
 - Inclusion of the new BB
 - Experimental phase
 - Validation phase
 - Design Rule Check (DRC) included



**SMART
PHOTONICS**

Independent InP Foundry

SMART Photonics
Photonic IC design manual

Version V 1.0
August 1, 2017

SMART Photonics

in collaboration with
Photonic Integration Group

Research Institute COBRA
Eindhoven University of Technology

CONFIDENTIAL

JEPPIX



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OPZuid
Europees Innovatieprogramma Zuid-Nederland

OpenPICs

FUTURE

MPW validation **MPW commercial** Tape-out

		SP19	SP20	SP21	SP22	SP23	SP24	SP25	SP26	SP27	SP28	SP29	SP30
		Dec-16	Mar-17	Jun-17	Sep-17	Dec-17	Mar-18	Jun-18	Sep-18	Dec-18	Mar-19	Jun-19	Sep-19
Modulator			1st	copy				2nd			3rd		
	SI-substrate		x										
	Plating	x											
	Effect MQW			x									
	AI-MQW							x					
	CL-TWE										x		
RF Line	conventional				1st					2nd			
	new planarization					to	be	determined					
SSC					x								
Prec. Filter	(ring, AWG, MZI)			1st			2nd			3rd			
	DBR	x EBL	EBL	DUV									
	DUV		x										
Low LW LD													
	DBR laser		1st			2nd			3rd				
	Triplex Hybrid				1st	Oct Lionix run	2nd	+Lionix run					
	High Q cavity laser									1st		2nd	
WP4 items	Zn diffusion				x								
	Thick insulation + RF				x								
	Improved etching						x						
Demo	both chips								1 st				

SUMMARY

- Within WP4 several improvements have been achieved:
 - Scanner Lithography
 - Support for Zn diffusion experiments
 - Development of new etching recipes for improved waveguide profile
- Release of a new Design Manual